SHOULDER

规格书编号 SPEC NO:

产品规格书 SPECIFICATION

CUSTOMER 客 户:_				
PRODUCT 产品:_	SAW RESONATOR			
MODEL NO 型 号:	HDR426.062M S20			
PREPARED 编制:	m the CHECKED 审核: 支房机			
APPROVED 批 准:_	DATE日期: 2011-3-14			
]*			
客户确认 CUSTOM	ER RECEIVED:			

审核 CHECKED	批准 APPROVED	日期 DATE

无锡市好达电子有限公司 Shoulder Electronics Limited



HDR426.062M S20

更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark



1. SCOPE

This specification shall cover the characteristics of 1-port SAW resonator with used for remote-control security.

2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V
AC Voltage Vpp	10V50Hz/60Hz
Operation temperature	-40°℃ to +85°℃
Storage temperature	-45°℃ to +85°℃
RF Power Dissipation	0dBm

2.2Electronic Characteristics

Item		Unites	Minimum	Typical	Maximum
Center Frequency		MHz	425.987	426.062	426.137
Insertion Loss		dB		1.5	2.5
Quality Factor Unload Q			5000	12800	
50Ω Loaded Q			1000	2000	
Temperature	Turnover Temperature	°C	10	25	40
Stability Freq.temp.Coefficient		ppm/°C2		0.032	
Frequency Aging		ppm/yr		<±10	
DC. Insulation Resistance		MΩ	1.0		
RF Equivalent RLC Model	Motional Resistance R1	Ω		19	26
	Motional Inductance L1	μH		74.835	
KLC MODEL	Motional Capacitance C1	fF		1.8717	
Transducer Static Capacitance		pF		2.0	

3. TEST CIRCUIT



4. DIMENSION

4-1 Typical dimension(unit: mm)



Sign	Data (unit: mm)	Sign	Data (unit: mm)
А	1.2±0.1	D	1.4±0.1
В	0.8±0.1	E	5.0±0.1
С	0.5	F	3.5±0.1

Pin	Configuration
1	Input / Output
3	Output / Input
2/4	Case Ground

4-2 Typical circuit board land patter



5. ENVIRONMENTAL CHARACTERISTICS

5-1 High temperature exposure

Subject the device to $+85^{\circ}$ C for 16 hours. Then release the resonator into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

5-2 Low temperature exposure

Subject the device to -40° C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

5-3 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2.2.

5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at 260° C $\pm 10^{\circ}$ C for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2.2.

5-5 Solderability

Subject the device terminals into the solder bath at 245° C for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2.2.

5-6 Mechanical shock

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SAW RESONATOR

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2.2.

5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2.2.

6. REMARK

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

7. Typical Application Circuit

Typical low-power Transmitter Application



Typical Local Oscillator Application

